

Microwave / Telecommunication Application

Application	Product Type	Pictures	Gowanda Advantages
Test Equipment	Mostly surface mount SM3, SML32, and SMRF1812, close tolerance, standard tolerance and horizontal SMD bases available		 Over molding the coil form promotes consistent dimensions for automation. Lead flattening process done in 2 stages to prevent damage to core. Molded flanges promote excellent vertical centering. SMRF1812S Shielded RF Inductors
Transmission Line Simulators	Air Coils and Chip Coils CC0603, CC0805 & CC1008		 UV Cap has excellent chemical resistance and securely bonded to component. Tested and meets the out gassing requirements of ASTM E 595. Medical grade Gold plated terminal prevents oxidation of nickel and provides excellent solderability. Air coils in various wire types, configurations and SMD cap
High Frequency Amplifiers & Bias T's	Conicals, C050FL, C100SM, C100FL, C225SM, C225FL, and C550FL		 One piece core & post for consistent mounting. 34° angle for C100SMNL & 100SMNR. 31° angle for C225SM Tested and meets the outgassing requirements of ASTM E 595. Thermal set epoxy mold bases. Gold plated copper wire with nickel barrier.

Gowanda Design Focus:

- RF Inductors: Surface mount, axial leaded, shielded, wire wound chips, air coils.
- High reliability, application specific components

Gowanda Advantages:

- Gowanda designs application specific inductors and transformers to meet your needs.
- Tested and meets the out gassing requirements of ASTM E 595. One piece core & post for consistent mounting.
- Medical grade cap is available.
- Molded flanges protecting coil winding during soldering and excellent vertical centering.
- Vertically integrated: Build most tooling, build or modify our own coil forms and mold application specific base designs.
- Environmentally tested for robustivity
- ISO9001 / AS9100 Quality Systems